# PME271E Series Metallized Impregnated Paper, Class X1, 300 VAC



### **Overview**

The PME271E Series consists of multilayer metallized paper, encapsulated and impregnated in self-extinguishing material meeting the requirements of UL 94 V–0.

## **Benefits**

- Approvals: ENEC, UL
- Rated voltage: 300 VAC 50/60 Hz
- Capacitance range: 0.01 0.22 µF
- Lead spacing: 15.2 25.4 mm
- Capacitance tolerance:  $\pm 20\%$  for C  $\leq$  0.1  $\mu$ F,  $\pm 10\%$  for C > 0.1  $\mu$ F
- Climatic category: 40/110/56/B, IEC 60068–1
- Tape and reel packaging in accordance with IEC 60286-2
- · RoHS Compliant and lead-free terminations
- Operating temperature range of -40°C to +110°C
- 100% screening factory test at 2,150 VDC
- Highest possible safety regarding active and passive flammability



Typical applications include worldwide use as an electromagnetic

interference suppressor in all X1 and across-the-line applications.

## Legacy Part Number System

PME271	E	(D)	510(0)	Μ	R30
Series	Rated Voltage (VAC)	Lead Spacing (mm)	Capacitance Code (pF)	Capacitance Tolerance	Packaging
X1, Metallized Paper	E = 300	Blank = Standard D = 22.5	The last three digits represent significant figures. The first digit specifies the total number of digits.		See Ordering Options Table

**Applications** 

## New KEMET Part Number System

Р	277	Q	E	103	М	300	Α
Capacitor Class	Series	Lead Spacing (mm)	Size Code	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VAC)	Packaging
P = Paper	X1, Metallized Paper	Q = 15.2 C = 20.3 S = 22.5 E = 25.4	See Dimension Table	First two digits represent significant figures. Third digit specifies number of zeros.	M = ±20% (for C ≤ 0.1 µF) K = ±10% (for C > 0.1 µF)	300 = 300	See Ordering Options Table



## Benefits cont'd

- Excellent self-healing properties which ensure long life even when subjected to frequent over-voltages
- Good resistance to ionization due to impregnated paper dielectric

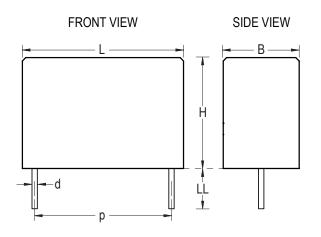
## **Ordering Options Table**

Lead Spacing Nominal (mm)	Type of Leads and Packaging	Lead Length (mm)	KEMET Lead and Packaging Code	Legacy Lead and Packaging Code
	Standard Lead and Packaging Options			
	Bulk (Bag) – Short Leads	6 +0/-1	С	R06
45.0	Bulk (Bag) – Max Length Leads	30 +5/-0	A	R30
15.2	Tape & Reel (Standard Reel)	H <sub>0</sub> = 18.5 +/-0.5	L	R19T0
	Other Lead and Packaging Options			
	Tape & Reel (Large Reel)	H <sub>0</sub> = 18.5 +/-0.5	Р	R19T1
	Standard Lead and Packaging Options			
	Bulk (Tray) – Short Leads	6 +0/-1	С	R06
20.3	Bulk (Bag) – Max Length Leads	30 +5/-0	A	R30
20.5	Tape & Reel (Standard Reel)	H <sub>0</sub> = 18.5 +/-0.5	L	R19T0
	Other Lead and Packaging Options			
	Tape & Reel (Large Reel)	H <sub>0</sub> = 18.5 +/-0.5	Р	R19T1
	Standard Lead and Packaging Options			
	Bulk (Tray) – Short Leads	6 +0/-1	С	R06
	Bulk (Bag) – Max Length Leads	30 +5/-0	A	R30
22.5	Tape & Reel (Standard Reel)	H <sub>o</sub> = 18.5 +/-0.5	L	R19T0
	Other Lead and Packaging Options	, v		
	Tape & Reel (Large Reel)	H <sub>0</sub> = 18.5 +/-0.5	Р	R19T1
	Standard Load and Deckering Out			
05 A	Standard Lead and Packaging Options			
25.4	Bulk (Tray) – Short Leads	6 +0/-1	C	R06
	Bulk (Bag) – Max Length Leads	30 +5/-0	A	R30

- High dV/dt capability
- Impregnated paper ensures excellent stability and reliability properties, particularly in applications with continuous operation



## **Dimensions – Millimeters**



Cine Code	р		В		Н		L		d	
Size Code	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance
QE	15.2	+/-0.4	5.2	Maximum	10.5	Maximum	18.5	Maximum	0.8	+/-0.05
QN	15.2	+/-0.4	7.3	Maximum	13	Maximum	19	Maximum	0.8	+/-0.05
QS	15.2	+/-0.4	8.5	Maximum	14.3	Maximum	18.5	Maximum	0.8	+/-0.05
CE	20.3	+/-0.4	7.6	Maximum	14	Maximum	24	Maximum	0.8	+/-0.05
СР	20.3	+/-0.4	11.3	Maximum	16.5	Maximum	24	Maximum	0.8	+/-0.05
SJ	22.5	+/-0.4	8	Maximum	17	Maximum	27	Maximum	0.8	+/-0.05
SP	22.5	+/-0.4	10	Maximum	19	Maximum	27	Maximum	0.8	+/-0.05
SU	22.5	+/-0.4	12	Maximum	22	Maximum	27	Maximum	0.8	+/-0.05
EE	25.4	+/-0.4	10.6	Maximum	16.1	Maximum	30.5	Maximum	1	+/-0.05
EJ	25.4	+/-0.4	12.1	Maximum	19	Maximum	30.5	Maximum	1	+/-0.05
			Note: See Ord	lering Options	Table for lead	length (LL) opti	ons.			



## **Performance Characteristics**

300 VAC 50/60 Hz					
0.01 – 0.22 µF					
$\pm 20\%$ for C $\leq$ 0.1 $\mu$ F, $\pm 10\%$ for C > 0	0.1 μF				
-40°C to +110°C					
40/110/56/B					
ENEC, UL					
Maximum Values at +23°C					
1 kHz	1.3%				
The 100% screening factory test is of voltage level is selected to meet the equipment standards. All electrical of test. It is not permitted to repeat this the capacitor. KEMET is not liable in	requirements in applicable characteristics are checked after the test as there is a risk to damage				
Minimum Values E	Between Terminals				
C ≤ 0.33 µF	≥ 12,000 MΩ				
C > 0.33 μF ≥ 4,000 MΩ • μF					
Recommended voltage ≤ 630 VDC					
	0.01 – 0.22 $\mu$ F ±20% for C ≤ 0.1 $\mu$ F, ±10% for C > 0 -40°C to +110°C 40/110/56/B ENEC, UL Maximum Va 1 kHz The 100% screening factory test is of voltage level is selected to meet the equipment standards. All electrical of test. It is not permitted to repeat this the capacitor. KEMET is not liable in Minimum Values E C ≤ 0.33 $\mu$ F C > 0.33 $\mu$ F				

## **Environmental Test Data**

Test	IEC Publication	Procedure
Endurance	IEC 60384–14	1.25 x V <sub>R</sub> VAC 50 Hz, once every hour increase to 1,000 VAC for 0.1 second, 1,000 hours at upper rated temperature
Vibration	IEC 60068–2–6 Test Fc	3 directions at 2 hours each 10 – 55 Hz at 0.75 mm or 98 m/s $^2$
Bump	IEC 60068–2–29 Test Eb	1,000 bumps at 390 m/s²
Change of Temperature	IEC 60068–2–14 Test Na	Upper and lower rated temperature 5 cycles
Active Flammability	IEC 60384–14	V <sub>R</sub> + 20 surge pulses at 2.5 kV (pulse every 5 seconds)
Passive Flammability	IEC 60384–14	IEC 60384–1, IEC 60695–11–5 Needle-flame test
Damp Heat Steady State	IEC 60068–2–78 Test Cab	+40°C and 93% RH, 56 days



5

## Approvals

Mark	Specification	File Number		
	EN/IEC 60384–14	SE/0140–15D		
c <b>FL</b> us	UL 60384-14 CAN/CSA-E60384-14-09	E73869		

## **Environmental Compliance**

All KEMET EMI capacitors are RoHS Compliant.

## Table 1 – Ratings & Part Number Reference

Capacitance	Maximum	n Dimensio	ns in mm	Lead	f	dV/dt	New KEMET Part	Legacy Part
Value (µF)	В	н	L	Spacing (p)	(MḦ́z)	(V/µs)	Number	Number
0.010	5.2	10.5	18.5	15.2	16	1200	P277QE103M300(1)	PME271E510M(1)
0.015	5.2	10.5	18.5	15.2	13	1200	P277QE153M300(1)	PME271E515M(1)
0.022	7.3	13	18.5	15.2	9.8	1200	P277QN223M300(1)	PME271E522M(1)
0.033	7.3	13	18.5	15.2	7	1200	P277QN333M300(1)	PME271E533M(1)
0.047	8.5	14.3	18.5	15.2	6.4	1200	P277QS473M300(1)	PME271E547M(1)
0.068	7.6	14	24	20.3	5.2	600	P277CE683M300(1)	PME271E568M(1)
0.1	11.3	16.5	24	20.3	4.1	600	P277CP104M300(1)	PME271E610M(1)
0.068	8	17	27	22.5	4.7	600	P277SJ683M300(1)	PME271ED5680M(1)
0.1	8	17	27	22.5	4.1	600	P277SJ104M300(1)	PME271ED6100M(1)
0.15	10	19	27	22.5	3.2	600	P277SP154K300(1)	PME271ED6150K(1)
0.22	12	22	27	22.5	2.5	600	P277SU224K300(1)	PME271ED6220K(1)
0.15	10.6	16.1	30.5	25.4	3.3	400	P277EE154K300(1)	PME271E615K(1)
0.22	12.1	19	30.5	25.4	2.6	400	P277EJ224K300(1)	PME271E622K(1)
Capacitance Value (µF)	B (mm)	H (mm)	L (mm)	Lead Spacing (p)	f <sub>。</sub> (MHz)	dV/dt (V/µs)	New KEMET Part Number	Legacy Part Number

(1) Insert lead and packaging code. See Ordering Options Table for available options.



6

## **Soldering Process**

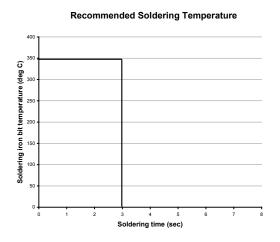
The implementation of the RoHS directive has resulted in the selection of SnAgCu (SAC) alloys or SnCu alloys as primary solder. This has increased the liquidus temperature from that of 183°C for SnPb eutectic alloy to 217 - 221°C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher pre-heat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is 160 - 170°C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 mm to 15 mm), and great care has to be taken during soldering. The recommended solder profiles from KEMET should be used. Please consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. Please see Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the above the recommended limits may result to degradation or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert throughhole parts after the curing of surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum two soldering cycles is recommended. Please allow time for the capacitor surface temperature to return to a normal temperature before the second soldering cycle.

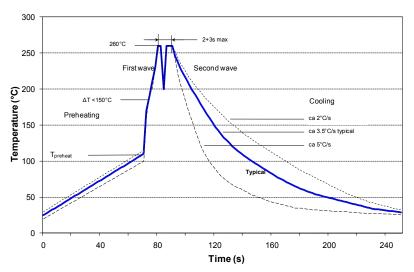
#### Manual Soldering Recommendations

Following is the recommendation for manual soldering with a soldering iron.



The soldering iron tip temperature should be set at 350°C (+10°C maximum) with the soldering duration not to exceed more than 3 seconds.

#### **Wave Soldering Recommendations**





## **Soldering Process cont'd**

#### Wave Soldering Recommendations cont'd

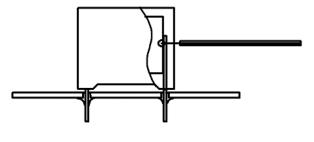
1. The table indicates the maximum set-up temperature of the soldering process Figure 1

Dielectric		imum Pre emperatu	Maximum Peak Soldering Temperature			
Film Material	Capacitor Pitch Pitch ≤ 10 mm = 15 mm		Capacitor Pitch > 15 mm	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm	
Polyester	130°C	130°C	130°C	270°C	270°C	
Polypropylene	100°C	110°C	130°C	260°C	270°C	
Paper	130°C	130°C	140°C	270°C	270°C	
Polyphenylene Sulphide	150°C	150°C	160°C	270°C	270°C	

2. The maximum temperature measured inside the capacitor:

Set the temperature so that inside the element the maximum temperature is below the limit:

Dielectric Film Material	Maximum temperature measured inside the element				
Polyester	160°C				
Polypropylene	110°C				
Paper	160°C				
Polyphenylene Sulphide	160°C				



Temperature monitored inside the capacitor.

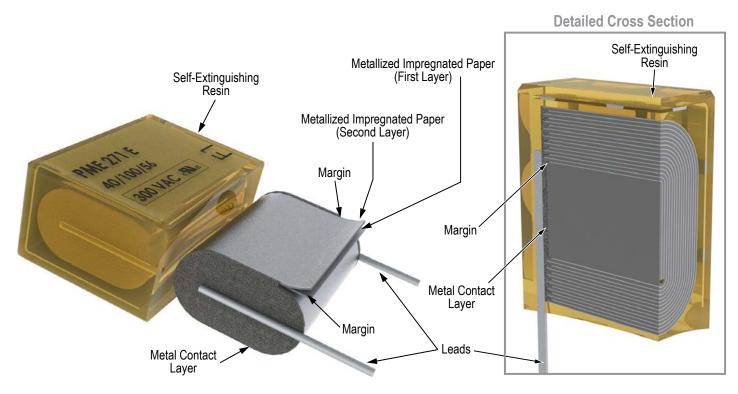
#### **Selective Soldering Recommendations**

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath as in normal flow soldering without touching the solder. When the board is over the bath, it is stopped and pre-designed solder pots are lifted from the bath with molten solder only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

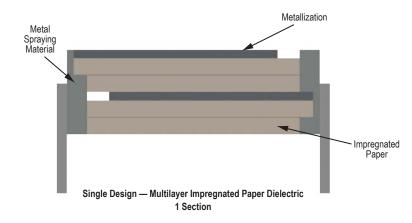
The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document, however, instead of two baths, there is only one bath with a time from 3 to 10 seconds. In selective soldering, the risk of overheating is greater than in double wave flow soldering, and great care must be taken so that the parts are not overheated.



## Construction

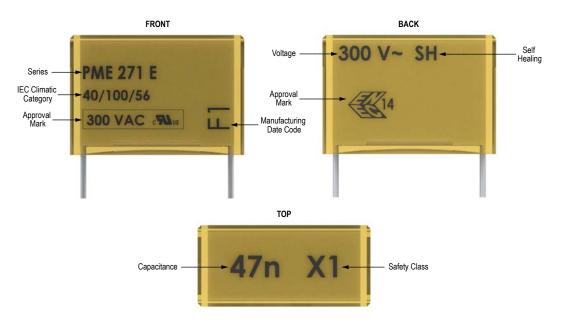


#### Winding Scheme





## Marking



## **Packaging Quantities**

Lead Spacing (mm)	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads	Bulk Long Leads	Standard Reel ø 360 mm	Large Reel ø 500 mm
	5.5	12.5	18	1000	500	600	
	6.5	12.5	18	600	400	400	
	7.5	14.5	18	600	400	400	
	8.5	16	18	400	250	400	
45.0	5.2	10.5	18.5	1000	500	600	
15.2	5.5	11	18.5	1000	500	500	
	6	12.5	18.5	600	400	400	
	7.3	13	18.5	600	400	400	800
	7.8	13.5	18.5	600	400	400	
	8.5	14.3	18.5	500	300	350	
			<b>0</b> (	(=00			
	7.6	14	24	1500	250	250	500
20.3	8.4	14	24	1200	200	250	500
20.5	9	15	24	1500	200	250	
	11.3	16.5	24	1000	150	180	400
	8	17	27	1200	200		
22.5	10	19	27	1200	150	200	
22.5	10	22	27	800	100	180	350
	12		21	000	100	100	300
	10.6	16.1	30.5	1000	150		
a= /	10.5	17.3	30.5	1000	100		
25.4	12.1	19	30.5	800	100		
	15.3	22	30.5	600	75		

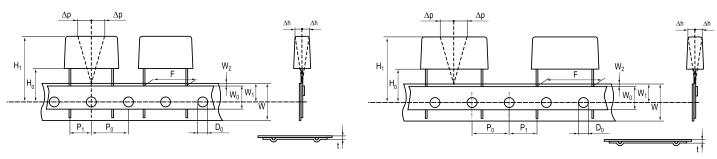
© KEMET Electronics Corporation • P.O. Box 5928 • Greenville, SC 29606 (864) 963-6300 • www.kemet.com



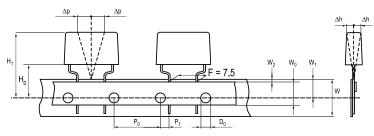
## Lead Taping & Packaging (IEC 60286-2)

#### Lead Spacing 10.2 – 15.2 mm

Lead Spacing 20.3 – 22.5 mm



#### Formed Leads from 10.2 to 7.5 mm



## **Taping Specification**

	Dimensions in mm										
Lead spacing	+6/-0.1	F	Formed 7.5	10.2	15.2	20.3	22.5	F			
Carrier tape width	+/-0.5	W	18	18	18	18	18	18+1/-0.5			
Hold-down tape width	+/-0.3	W <sub>0</sub>	9	12	12	12	12				
Position of sprocket hole	+/-0.5	W <sub>1</sub>	9	9	9	9	9	<b>9</b> +0.75/-0.5			
Distance between tapes	Maximum	W <sub>2</sub>	3	3	3	3	3	3			
Sprocket hole diameter	+/-0.2	D	4	4	4	4	4	4			
Feed hole lead spacing	+/-0.3	P <sub>0</sub> <sup>(1)</sup>	12.7(4)	12.7	12.7	12.7	12.7	12.7			
Distance lead – feed hole	+/-0.7	P <sub>1</sub>	3.75	7.6	5.1	8.9	5.3	P <sup>1</sup>			
Deviation tape – plane	Maximum	Δp	1.3	1.3	1.3	1.3	1.3	1.3			
Lateral deviation	Maximum	$\Delta h$	2	2	2	2	2	2			
Total thickness	+/-0.2	t	0.7	0.7	0.7	0.7	0.9 <sup>max</sup>	0.9 <sup>max</sup>			
Sprocket hole/cap body	Nominal	H <sub>0</sub> <sup>(2)</sup>	18+2/-0	18+2/-0	18+2/-0	18+2/-0	18.5+/-0.5	18+2/-0			
Sprocket hole/top of cap body	Maximum	H <sub>1</sub> <sup>(3)</sup>	35	35	35	35	58	58 <sup>max</sup>			

(1) Maximum cumulative feed hole error, 1 mm per 20 parts.(2) 16.5 mm available on request.

(3) Depending on case size.(4) 15 mm available on request.



## Lead Taping & Packaging (IEC 60286–2) cont'd

## **Ammo Specifications**

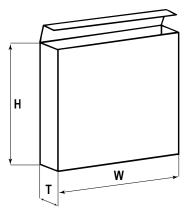
Series	Dimensions (mm)		
Series	Н	W	Т
R4x, R4x+R, R7x, RSB			
F5A, F5B, F5D	360	340	59
F6xx, F8xx			
PHExxx, PMExxx, PMRxxx	330	330	50

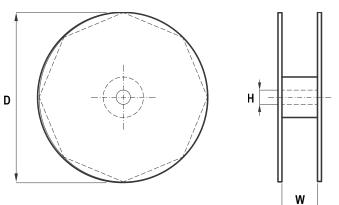
## **Reel Specifications**

Carries	Dimensions (mm)		
Series	D	Н	W
R4x, R4x+R, R7x, RSB	055		
F5A, F5B, F5D	355 500	30 25	55 (Max)
F6xx, F8xx	500	20	
PHExxx, PMExxx, PMRxxx	360 500	30	46 (Max)

## Manufacturing Date Code (IEC-60062)

Y = Year, Z = Month					
Year	Code	Month	Code		
2000	М	January	1		
2001	N	February	2		
2002	Р	March	3		
2003	R	April	4		
2004	S	Мау	5		
2005	Т	June	6		
2006	U	July	7		
2007	V	August	8		
2008	W	September	9		
2009	Х	October	0		
2010	A	November	Ν		
2011	В	December	D		
2012	С				
2013	D				
2014	E				
2015	F				
2016	Н				
2017	J				
2018	K				
2019	L				
2020	М				







### KEMET Corporation World Headquarters

2835 KEMET Way Simpsonville, SC 29681

Mailing Address: P.O. Box 5928 Greenville, SC 29606

www.kemet.com Tel: 864-963-6300 Fax: 864-963-6521

Corporate Offices Fort Lauderdale, FL Tel: 954-766-2800

### **North America**

Northeast Wilmington, MA Tel: 978-658-1663

Southeast Lake Mary, FL Tel: 407-855-8886

**Central** Novi, MI Tel: 248-994-1030

Irving, TX Tel: 972-915-6041

West Milpitas, CA Tel: 408-433-9950

**Mexico** Guadalajara, Jalisco Tel: 52-33-3123-2141

### Europe

Southern Europe Sasso Marconi, Italy Tel: 39-051-939111

Skopje, Macedonia Tel: 389-2-55-14-623

**Central Europe** Landsberg, Germany Tel: 49-8191-3350800

Kamen, Germany Tel: 49-2307-438110

Northern Europe Wyboston, United Kingdom Tel: 44-1480-273082

Espoo, Finland Tel: 358-9-5406-5000

### Asia

Northeast Asia Hong Kong Tel: 852-2305-1168

Shenzhen, China Tel: 86-755-2518-1306

Beijing, China Tel: 86-10-5877-1075

Shanghai, China Tel: 86-21-6447-0707

Seoul, South Korea Tel: 82-2-6294-0550

Taipei, Taiwan Tel: 886-2-27528585

Southeast Asia Singapore Tel: 65-6701-8033

Penang, Malaysia Tel: 60-4-6430200

Bangalore, India Tel: 91-806-53-76817

Note: KEMET reserves the right to modify minor details of internal and external construction at any time in the interest of product improvement. KEMET does not assume any responsibility for infringement that might result from the use of KEMET Capacitors in potential circuit designs. KEMET is a registered trademark of KEMET Electronics Corporation.



## Disclaimer

All product specifications, statements, information and data (collectively, the "Information") in this datasheet are subject to change. The customer is responsible for checking and verifying the extent to which the Information contained in this publication is applicable to an order at the time the order is placed.

All Information given herein is believed to be accurate and reliable, but it is presented without guarantee, warranty, or responsibility of any kind, expressed or implied.

Statements of suitability for certain applications are based on KEMET Electronics Corporation's ("KEMET") knowledge of typical operating conditions for such applications, but are not intended to constitute – and KEMET specifically disclaims – any warranty concerning suitability for a specific customer application or use. The Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by KEMET with reference to the use of KEMET's products is given gratis, and KEMET assumes no obligation or liability for the advice given or results obtained.

Although KEMET designs and manufactures its products to the most stringent quality and safety standards, given the current state of the art, isolated component failures may still occur. Accordingly, customer applications which require a high degree of reliability or safety should employ suitable designs or other safeguards (such as installation of protective circuitry or redundancies) in order to ensure that the failure of an electrical component does not result in a risk of personal injury or property damage.

Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicted or that other measures may not be required.

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Film Capacitors category:

Click to view products by Kemet manufacturer:

Other Similar products are found below :

 F339X134748MIP2T0
 F450KG153J250ALH0J
 750-1018
 FKP1-1500160010P15
 FKP1R031007D00JYSD
 FKP1R031507E00JYSD

 FKP1U024707E00KYSD
 82DC4100CK60J
 82EC1100DQ50K
 PFR5101J100J11L16.5TA18
 PME261JB5220KR19T0
 A451GK223M040A

 A561ED221M450A
 QXJ2E474KTPT
 QXL2B333KTPT
 R49AN347000A1K
 EEC2G505HQA406
 B25668A6676A375
 B25673A4282E140

 BFC233868148
 BFC2370GC222
 C3B2AD44400B20K
 C4ASWBU3220A3EK
 CB027C0473J- CB17710184J- CB182K0184J- 23PW210

 950CQW5H-F
 SBDC3470AA10J
 SCD105K122A3-22
 2N3155
 A571EH331M450A
 FKP1-2202KV5P15
 FKS3-680040010P10

 QXL2E473KTPT
 445450-1
 B25669A3996J375
 46KI322000M1M
 46KR415050M1K
 4BSNBX4100ZBFJ
 MKP383510063JKP2T0

 MKPY2-.02230020P15
 MKT 1813-368-015
 4055292001
 46KN410000N1K
 EEC2E106HQA405
 EEC2G205HQA402
 EEC2G805HQA415

 P409CP224M250AH470
 82EC2150DQ50K
 A6KN410000N1K
 EEC2E106HQA405
 EEC2G205HQA402
 EEC2G805HQA415